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Form PTO-1595 (Rev. 09/04) 05 - 07 - 2 OMB No. 0651-0027 (exp. 6/30/2005)	008 U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office
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Shigemitsu YAMAOKA,	Name: Sony Corporation
Ryo KAMIYA	Internal Address:
Execution Date(s) 03/28/2008, 03/12/2008	Street Address: 1-7-1 Konan
Additional name(s) of conveying party(ies) attached? Yes V No	
3. Nature of conveyance:	Minato-ku, Tokyo, Japan
✓ Assignment	City:
Security Agreement Change of Name	State:
Government Interest Assignment	Country:Zip:
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	document is being filed together with a new application.
A. Patent Application No.(s)	B. Patent No.(s)
p กละไปครัก (ก็จังกังไว) เชิงิลิตง43	
EL HOLDE CA	<u>_</u>
Additional numbers att	
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name:Robert J. Depke	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: ROCKEY, DEPKE & LYONS, LLC.	Authorized to be charged by credit card
	Authorized to be charged to deposit account
Street Address: 233 S. Wacker Dr.	✓ Enclosed
Suite 5450	None required (government interest not affecting title)
City: Chicago	8. Payment Information
State: <u>IL</u> Zip: 60606	a. Credit Card Last 4 Numbers Expiration Date
Phone Number: <u>312-277-2006</u>	_
Fax Number: <u>312-441-0570</u>	b. Deposit Account Number
Email Address: rdepker@rdfk-faw.com	Authorized User Name
9. Signature:	4/29/26
Signature	Date
Robert J. Depke Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:

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PATENT

REEL: 020923 FRAME: 0613

Docket Number: <u>075834.00907</u>

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING APPRATUS, IMAGE PROCESSING METHOD, PROGRAM THEREFOR,

AND RECORDING MEDIUM IN WHICH THE PROGRAM IS RECORDED

for which an application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, the entire right, title and interest in the said invention, said application, including any divisions and continuations as well as any reissues and reexaminations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

International Application No. PCT/JP2	006/322498 Filing Date: November 10, 2006
This assignment executed on the dates indicate	ed below.
Shigemitsu YAMAOKA	,
Name of first or sole inventor	Execution date of U.S. Patent Application
Tokyo, JAPAN	
Residence of first or sole inventor	
Synt	Mar. 28, 2508
Signature of First or sole inventor	Date of this Assignment

PATENT REEL: 020923 FRAME: 0614

Ryo KAMIYA Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, JAPAN Residence of second inventor	
Signature of second inventor	Mard 12 2008 Date of this Assignment
Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	
Signature of third inventor	Date of this Assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this Assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this Assignment
Name of sixth inventor	Execution date of U.S. Patent Application
Residence of sixth inventor	
Signature of sixth inventor	Date of this Assignment
Name of seventh inventor	Execution date of U.S. Patent Application
Residence of seventh inventor	
Signature of seventh inventor	Date of this Assignment

PATENT REEL: 020923 FRAME: 0615

RECORDED: 04/29/2008